NOTES:


2. DATUM PLANE (H-) IS LOCATED AT MOLD PARTING LINE AND COINCIDENT WITH LEAD, WHERE LEAD EXITS PLASTIC BODY AT BOTTOM OF PARTING LINE.

3. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.25 MM ON D1 AND E1 DIMENSIONS.

4. THE TOP OF PACKAGE IS SMALLER THAN THE BOTTOM OF PACKAGE BY 0.15 MILLIMETERS.

5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 MM TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.

6. ALL DIMENSIONS ARE IN MILLIMETERS.

7. THIS OUTLINE CONFORMS TO JEDEC PUBLICATION 95, REGISTRATION MS-026.

8. LEADS SHALL BE COPLANAR WITHIN .004 INCH.

9. MARKING SHOWN IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

10. NUMBER OF LEADS ARE SHOWN FOR REFERENCE ONLY.

11. ALL DIMENSIONS APPLY TO BOTH LEADED (−) AND PbFREE (+) PKG. CODES.